

METHOD OF COUPLING A BARRIER LAYER  
TO A SUBSTRATE OF A FLUID EJECTION DEVICE

ABSTRACT

A method of coupling a barrier layer to a substrate of a fluid ejection device includes disposing a mechanical intercoupling structure on a substrate at least one fluid ejector thereon; disposing a chamber layer over said substrate, wherein side walls of an ejection chamber are defined by the chamber layer; and substantially embedding said mechanical intercoupling structure with the chamber layer.

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